

# 1N4938



## Color Band Denotes Cathode

# **Small Signal Diode**

# Absolute Maximum Ratings \* T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
$V_{RRM}$	Maximum Repetitive Reverse Voltage	200	V
F(AV)	Average Rectified Forward Current	500	mA
I <sub>FSM</sub>	Non-repetitive Peak Forward Surge Current		
	Pulse Width = 1.0 second	1.0	Α
	Pulse Width = 1.0 microsecond	4.0	Α
STG	Storage Temperature Range	-65 to +200	°C
J	Operating Junction Temperature	175	°C

<sup>\*</sup> These ratings are limiting values above which the serviceability of the diode may be impaired.

# **Thermal Characteristics**

Symbol	Parameter	Value	Units
P <sub>D</sub>	Power Dissipation	500	mW
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	300	°C/W

# Electrical Characteristics T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Max.	Units
V <sub>R</sub>	Breakdown Voltage	I <sub>R</sub> = 100μA	200		V
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> = 100mA		1.0	V
I <sub>R</sub>	Reverse Leakage	V <sub>R</sub> = 75V V <sub>R</sub> = 175V, T <sub>A</sub> = 175°C		100 100	nA μA
C <sub>T</sub>	Total Capacitance	$V_R = 0V$ , $f = 1MHz$		5	pF
t <sub>rr</sub>	Reverse Recovery Time	$I_F = 3\text{mA}, I_R = 30\text{mA}$ $I_{rr} = 1\text{mA}, R_L = 100\Omega$		50	ns

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NOTES:

1) These ratings are based on a maximum junction temperature of 200 degrees C.

2) These are steady limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

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